

## DECLARATION FOR U.S. PATENT APPLICATION

# 10/501813

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

### METHOD FOR FORMING HIGH-Re-CONTENT ALLOY FILM THROUGH ELECTROPLATING PROCESS

the specification of which is attached hereto unless the following is checked

☐ was filed on 19 July 2004 as United States Application Number \_\_\_\_\_ and was filed on 17 January 2003 as PCT International Application Number PCT/JP03/00354 and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) – (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

#### Priority Claimed

(List prior foreign applications. See note A)

<u>2002-10665</u> (Number)	<u>Japan</u> (Country)	<u>18/January/2002</u> (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
<u>2002-10811</u> (Number)	<u>Japan</u> (Country)	<u>18/January/2002</u> (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No

(See note B) ☐ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

#### Status

(List prior U.S. Applications)

_____ (Application Serial No.)	_____ (Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
_____ (Application Serial No.)	_____ (Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
_____ (Application Serial No.)	_____ (Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
_____ (Application Serial No.)	_____ (Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

**Customer Number: 38834**

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP  
1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)

1-00

Full name of sole or first inventor (given name, family name) Toshio NARITA  
Inventor's signature Toshio Narita Date 06/Sep./2004  
Residence Hokkaido, JAPAN JPX Citizenship JAPAN  
Post Office Address 7-8, Shinkotoni 1-Jyo 9-chome, Kita-ku, Sapporo-shi, Hokkaido 001-0901 JAPAN

2-00

Full name of second inventor (given name, family name) Shigenari HAYASHI  
Inventor's signature Shigenari Hayashi Date 06/Sep./2004  
Residence Hokkaido, JAPAN JPX Citizenship JAPAN  
Post Office Address Room 801, Infinito Odori, 1-36, Odori Nishi 18-chome, Chuo-ku, Sapporo-shi, Hokkaido 060-0042 JAPAN

3-00

Full name of third inventor (given name, family name) Takayuki YOSHIOKA  
Inventor's signature Takayuki Yoshioka Date 17/Sep./2004  
Residence Kanagawa, JAPAN JPX Citizenship JAPAN  
Post Office Address Room 201, Heights Yamato, 11-14, Take 3-chome, Yokosuka-shi, Kanagawa 238-0313 JAPAN

4-00

Full name of fourth inventor (given name, family name) Hiroshi YAKUWA  
Inventor's signature Hiroshi Yakuwa Date 03/September/2004  
Residence Kanagawa, JAPAN JPX Citizenship JAPAN  
Post Office Address Room 401, 10-19, Inari 1-chome, Fujisawa-shi, Kanagawa 251-0862 JAPAN

5-00

Full name of fifth inventor (given name, family name) Michiaki SOUMA  
Inventor's signature Michiaki Souma Date 06/SEP/2004  
Residence Hokkaido, JAPAN JPX Citizenship JAPAN  
Post Office Address Room 201, Kopo 6-Jyo, 2-21, Hassamu 6-Jyo 5-chome, Nishi-ku, Sapporo-shi, Hokkaido 063-0826 JAPAN

6-00

Full name of sixth inventor (given name, family name) Michihisa FUKUMOTO  
Inventor's signature Michihisa Fukumoto Date 13/Sep./2004  
Residence Akita, JAPAN JPX Citizenship JAPAN  
Post Office Address Room 103, Towny-Tegata, 36-3, Aza Ougitada, Tegata, Akita-shi, Akita 010-0851 JAPAN

## NOTES

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate city and state, for residence outside the U.S., indicate city and country. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.

**DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION**

米国特許出願宣言書及び委任状

**Japanese Language Declaration**

日本語宣言書（英語でご記入下さい）

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

下記の氏名の発明者として、私は以下の通り宣言します。私の住所、郵便物送付先、国籍は下記の私の氏名の後に記載された通りです。下記の名称の発明に関して請求の範囲に記載され、特許出願している発明内容について、私が最初かつ唯一の発明者（下記の氏名が一つの場合）もしくは最初かつ共同発明者（下記の氏名が複数の場合）であると信じています。

Title（発明の名称）：

SILICON COMPOUND

of which is described and claimed in:

上記名称の発明を記述し特許請求する書類は、以下のいずれかです。

( ) the attached specification, or  
本状に添付した明細書

( ) the specification in the application Serial No. \_\_\_\_\_ filed \_\_\_\_\_;  
(上記日付) 提出の米国出願番号 (上記出願番号) で、  
and with amendments through \_\_\_\_\_ (if applicable), or  
(該当する場合) (上記日付等) に訂正された明細書

(X) the specification in International Application No. PCT/IP03/011856, filed on 17 September 2003,  
and as amended on \_\_\_\_\_ (if applicable).  
(上記日付) 提出の特許協力条約に基づく国際出願番号PCT/ (上記出願番号) で、  
(該当する場合) (上記日付等) に訂正された明細書

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

私は、特許請求の範囲を含む上記訂正後の明細書を検討し、内容を理解していることをここに表明します。

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56.

私は、連邦規則法典第37編第1条56項に定義されるとおり、特許性の有無について重要な情報を開示する義務があることを認めます。

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

私は、米国法典第35編119条（もし本願が意匠に関する出願の場合は172条）に基づき、下記の特許出願又は発明者証の出願についての優先権の利益をここに主張するとともに、優先権主張の基礎となる出願日を有する、本出願の前に出願された特許または発明者証の出願を以下にすべて、枠内をマークすることで示しています。

COUNTRY 国名	APPLICATION NO. 出願番号	DATE OF FILING 出願日	PRIORITY CLAIMED 優先権主張
JAPAN	2002-270429	September 17, 2002	Yes
JAPAN	2003-129350	May 7, 2003	Yes

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s), or 365(c) of any PCT international application designating the United States listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations,

§1.56 which become available between the filing date of the prior application and the national or PCT international filing date of this application:


私は、米国法典第35編120条に基づいて下記の米国特許出願、又は米国を指定している特許協力条約365条(c)に基づく優先権をここに主張します。また、本出願の各請求の範囲の技術的事項が米国法典第35編112条第1段で規定された方法で先行する米国特許出願に開示されていない限り、当該先行出願の出願日以降で本出願の国内又はPCTに基づく国際出願の提出日までの期間中に入手できるようになった、連邦規則法典第37編1条56項で定義された特許性の有無に関する重要な情報について、開示義務があることを認識しています。

APPLICATION SERIAL NO. 出願番号	U.S. FILING DATE 米国出願日	STATUS: PATENTED, PENDING, ABANDONED 現状:特許許可済、係属中、放棄済

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils E. Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith. 私は、本出願の審査及び本出願に関連するすべてのビジネスに関わる手続きを米国特許商標局に対して遂行するため、共同でWENDEROTH, LIND & PONACK, L.L.P.法律事務所を構成しているMichael R. Davis (登録番号第25,134号)、Matthew M. Jacob (登録番号第25,154号)、Warren M. Cheek, Jr. (登録番号第33,367号)、Nils E. Pedersen (登録番号第33,145号)、Charles R. Watts (登録番号第33,142号)及びMichael S. Huppert (登録番号第40,268号)並びにカスタマー番号第000513号に付帯する他の弁護士及び弁理士を名いたします。

I hereby authorize the U.S. attorneys named herein to accept and follow instructions from \_\_\_\_\_ as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

私は、本願に関して米国特許商標局で行われるあらゆる手続行為に関し、ここに指名した米国弁護士を、弁護士と私との間で直接連絡をとることなく、(米国弁護士が連絡する相手先。譲受人もしくは日本の代理人等)からの指示を受けそれに従うことを、ここに承認します。指示を送る者に変更される場合は、その旨を上記米国弁護士は私から告知されます。

Direct Correspondence to Customer No: (カスタマー番号)	Direct Telephone Calls to: (連絡先電話番号)
 <b>000513</b> PATENT TRADEMARK OFFICE	WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021  Phone:(202) 721-8200 (電話番号) Fax:(202) 721-8250 (ファクシミリ番号)

Full Name of First Inventor 第一発明者の氏名	FAMILY NAME 姓 YAMAHIRO, Mikio	FIRST GIVEN NAME 氏名	SECOND GIVEN NAME ミドルネーム等その他の氏名
Residence & Citizenship 居住地及び国籍	CITY 市 Yokohama-shi, Kanagawa, Japan	STATE OR COUNTRY 州又は国名	COUNTRY OF CITIZENSHIP 国籍 Japan
Post Office Address 郵便物送付先	ADDRESS 住所 C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan	CITY 市	STATE OR COUNTRY 州又は国名
		ZIP CODE 郵便番号	

<b>Full Name of Second Inventor</b> 第二発明者の氏名	<b>FAMILY NAME</b> 姓	<b>FIRST GIVEN NAME</b> 氏	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	OIKAWA,	Hisao	
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Yokohama-shi,	Kanagawa, Japan	Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan		

<b>Full Name of Third Inventor</b> 第三発明者の氏名	<b>FAMILY NAME</b> 姓	<b>FIRST GIVEN NAME</b> 氏	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	YOSHIDA,	Kazuhiro	
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Yokohama-shi,	Kanagawa, Japan	Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan		

<b>Full Name of Fourth Inventor</b> 第四発明者の氏名	<b>FAMILY NAME</b> 姓	<b>FIRST GIVEN NAME</b> 氏	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	ITO,	Kenya	
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Yokohama-shi,	Kanagawa, Japan	Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan		

<b>Full Name of Fifth Inventor</b> 第五発明者の氏名	<b>FAMILY NAME</b> 姓	<b>FIRST GIVEN NAME</b> 氏	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	YAMAMOTO,	Yasuhiro	
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Yokohama-shi,	Kanagawa, Japan	Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan		

<b>Full Name of Sixth Inventor</b> 第六発明者の氏名	<b>FAMILY NAME</b> 姓	<b>FIRST GIVEN NAME</b> 氏	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	TANAKA,	Masami	
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Yokohama-shi,	Kanagawa, Japan	Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan		

<b>Full Name of Seventh Inventor</b> 第七発明者の氏名	<b>FAMILY NAME</b> 姓名	<b>FIRST GIVEN NAME</b> 氏名	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	OOTAKE, Nobumasa		
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Yokohama-shi, Kanagawa, Japan		Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan		

<b>Full Name of Eighth Inventor</b> 第八発明者の氏名	<b>FAMILY NAME</b> 姓名	<b>FIRST GIVEN NAME</b> 氏名	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	WATANABE, Kenichi		
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Yokohama-shi, Kanagawa, Japan		Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	C/O CHISSO CORPORATION, YOKOHAMA RESEARCH CENTER, 5-1, Okawa, Kanazawa-ku, Yokohama-shi, Kanagawa 236-8605 Japan		

<b>Full Name of Ninth Inventor</b> 第九発明者の氏名	<b>FAMILY NAME</b> 姓名	<b>FIRST GIVEN NAME</b> 氏名	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	OHNO, Kohji		
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Uji-shi, Kyoto, Japan		Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	Laboratory of Polymeric Materials, Institute for Chemical Research(ICR), Kyoto University, Gokasho, Uji-shi, Kyoto 611-0011 Japan		

<b>Full Name of Tenth Inventor</b> 第十発明者の氏名	<b>FAMILY NAME</b> 姓名	<b>FIRST GIVEN NAME</b> 氏名	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	TSUJII, Yoshinobu		
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Uji-shi, Kyoto, Japan		Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	Laboratory of Polymeric Materials, Institute for Chemical Research(ICR), Kyoto University, Gokasho, Uji-shi, Kyoto 611-0011 Japan		

<b>Full Name of Eleventh Inventor</b> 第十一発明者の氏名	<b>FAMILY NAME</b> 姓名	<b>FIRST GIVEN NAME</b> 氏名	<b>SECOND GIVEN NAME</b> ミドルネーム等その他の氏名
	FUKUDA, Takeshi		
<b>Residence &amp; Citizenship</b> 居住地及び国籍	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名	<b>COUNTRY OF CITIZENSHIP</b> 国籍
	Uji-shi, Kyoto, Japan		Japan
<b>Post Office Address</b> 郵便物送付先	<b>ADDRESS</b> 住所	<b>CITY</b> 市	<b>STATE OR COUNTRY</b> 州又は国名
	Laboratory of Polymeric Materials, Institute for Chemical Research(ICR), Kyoto University, Gokasho, Uji-shi, Kyoto 611-0011 Japan		

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful

false statements may jeopardize the validity of the application or any patent issued thereon.

私は、私自身の知識に基づいて本宣言書中で私が行う表明が真実であり、かつ私の入手した情報と私の信じるところに基づく表明がすべて真実であると信じていること、さらに故意になされた虚偽の表明及びそれと同等の行為は米国法典第18編第1001条に基づき、罰金または拘禁、もしくはその両方により処罰されること、そしてそのような故意による虚偽の声明を行えば、出願した、又は既に許可された特許の有効性が失われることを認識し、よってここに上記のごとく宣誓を致します。

1st Inventor <u>Mikio Yamahiro</u> 第一発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
2nd Inventor <u>Hisao Iihara</u> 第二発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
3rd Inventor <u>Kazuhisa Yoshida</u> 第三発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
4th Inventor <u>Kenya Ito</u> 第四発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
5th Inventor <u>Yasuhiko Yamamoto</u> 第五発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
6th Inventor <u>Masami Tanaka</u> 第六発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
7th Inventor <u>Kobumasa Otake</u> 第七発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
8th Inventor <u>Kenichi Watanabe</u> 第八発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
9th Inventor <u>大野 工 司</u> 第九発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
10th Inventor <u>江 井 石 田</u> 第十発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付
11th Inventor <u>福 口 裕</u> 第十一発明者 (署名、ローマ字もしくは漢字)	Date March 18, 2005	署名の日付

The above application may be more particularly identified as follows:  
上記出願は、さらに具体的には以下のように特定されます。

U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_  
(上記出願日) 提出の米国特許出願第 (上記出願番号) 号

Applicant Reference Number \_\_\_\_\_ Atty Docket No. \_\_\_\_\_  
出願人側整理番号 (上記番号) 米国弁護士側管理番号 (上記番号)

Title of Invention  
発明の名称